

### 20mm BIG LAMP

Part Number: DLC2/6ID

HIGH EFFICIENCY RED

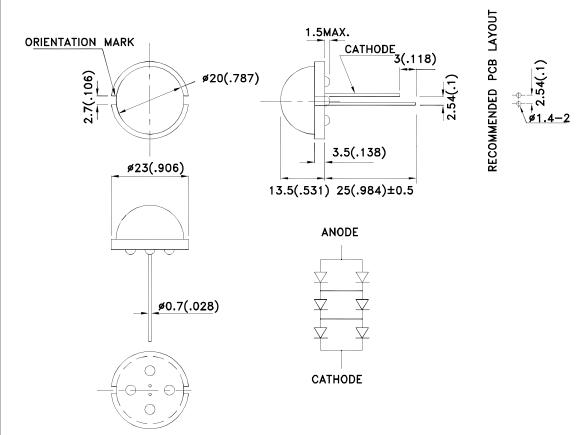
### **Features**

- 2 pins.
- High luminous intensity.
- Low power consumption.
- · Wide viewing angle.
- Categorized for luminous intensity.
- Excellent on/off contrast.
- Easy mounting on P.C. board or sockets.
- · Solid state reliability.
- RoHS compliant.

## **Description**

The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.

# Package Dimensions & Internal Circuit Diagram



### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.
- 3. Lead spacing is measured where the lead emerge from the package.
- 4. Specifications are subject to change without notice.





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# Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20 mA		Viewing Angle [1]
			Min.	Тур.	201/2
DLC2/6ID	HIGH EFFICIENCY RED (GaAsP/GaP)	RED DIFFUSED	18	60	120°

1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2.Luminous Intensity / Luminous Flux: +/-15%.

# Electrical / Optical Characteristics at T<sub>A</sub>=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	High Efficiency Red	627		nm	IF=20mA
λD [1]	Dominant Wavelength	High Efficiency Red	625		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	High Efficiency Red	45		nm	IF=20mA
С	Capacitance	High Efficiency Red	15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	High Efficiency Red	5.7	7.5	V	IF=20mA
lr	Reverse Current	High Efficiency Red		20	uA	VR = 15V

## Notes:

- Wavelength: +/-1nm.
   Forward Voltage: +/-0.1V.

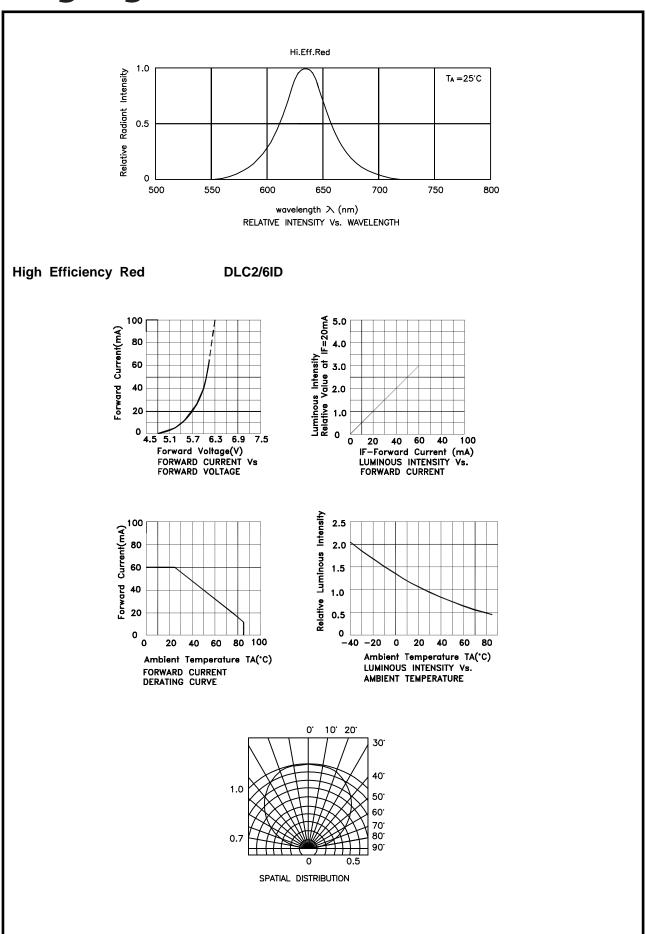
## Absolute Maximum Ratings at Ta=25°C

Parameter	Red	Units		
Power dissipation	450	mW		
Forward Current	60	mA		
Reverse Voltage	15	V		
Peak Forward Current[1]	320	mA		
Operating/Storage Temperature	-40°C To +85°C			
Lead Solder Temperature [2]	260°C For 3~5 Seconds			

- 1. The chips are three in series and two parallel.
- 2. 2mm below package base.

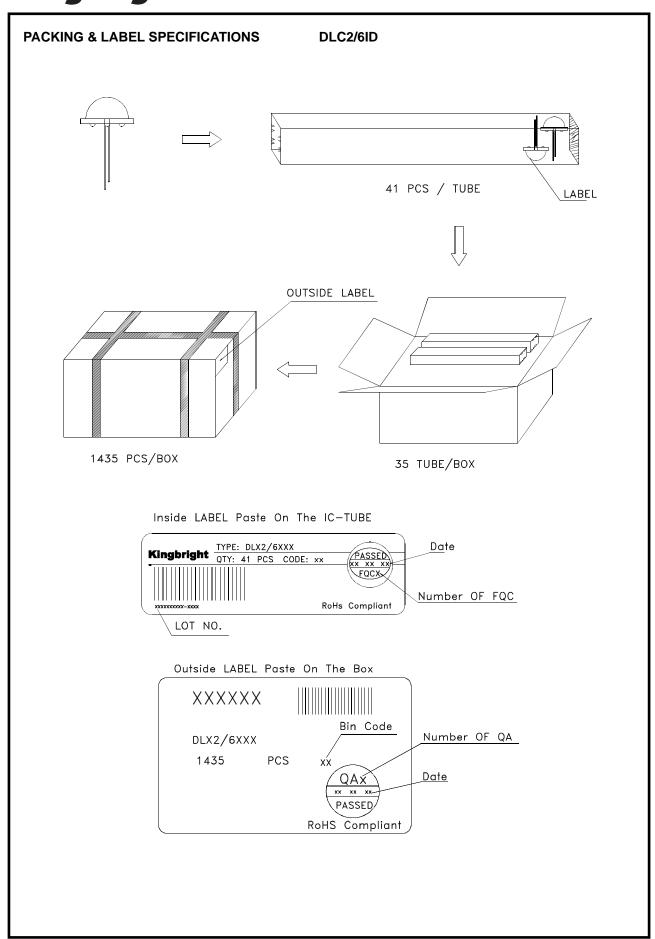
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